1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD128 small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Average forward current: I_{F(AV)} ≤ 2 A
- Reverse voltage: V_R ≤ 100 V
- Low forward voltage: V_F = 710 mV
- High power capability due to clip-bonding technology
- Extremely low leakage current
- High temperature T_i≤ 175 °C
- Small and flat lead SMD plastic package
- · AEC-Q101 qualified
- Capable for reflow and wave soldering

3. Applications

- · Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Reverse polarity protection
- Low power consumption applications

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{F(AV)}	average forward current	δ = 0.5 ; f = 20 kHz; $T_{sp} \le$ 165 °C; square wave	-	-	2	Α
V_R	reverse voltage	T _j = 25 °C	-	-	100	٧
V _F	forward voltage	$I_F = 2 \text{ A}; t_p \le 300 \mu\text{s}; \delta \le 0.02 ;$ $T_j = 25 \text{ °C}$	-	710	770	mV
I _R	reverse current	$V_R = 100 \text{ V}; t_p \le 300 \mu\text{s}; \delta \le 0.02 ;$ $T_j = 25 ^{\circ}\text{C}$	-	70	300	nA



5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]		1 [2
2	A	anode	1 2 CFP5 (SOD128)	sym001

^[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
PMEG10020AELP	CFP5	plastic, surface mounted package; 2 terminals; 4 mm pitch; 3.8 mm x 2.6 mm x 1 mm body	SOD128			

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG10020AELP	DM

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _R	reverse voltage	T _j = 25 °C		-	100	V
I _F	forward current	T _{sp} = 160 °C; δ = 1		-	2.83	Α
I _{F(AV)}	average forward current	δ = 0.5 ; f = 20 kHz; $T_{amb} \le 100 ^{\circ}\text{C}$; square wave	[1]	-	2	Α
		δ = 0.5 ; f = 20 kHz; $T_{sp} \le 165$ °C; square wave		-	2	Α
I _{FSM}	non-repetitive peak forward current	t_p = 8 ms; $T_{j(init)}$ = 25 °C; square wave		-	50	Α
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[2]	-	750	mW
			[3]	-	1250	mW
			[1]	-	2500	mW
Tj	junction temperature			-	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C

- [1] Device mounted on a ceramic Printed-Circuit Board (PCB), Al₂O₃, standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
uig-a)	thermal resistance from junction to ambient	in free air	[1] [2]	-	-	200	K/W
			[1] [3]	-	-	120	K/W
			[1] [4]	-	-	60	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[5]	-	-	12	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².
- [4] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.
- [5] Soldering point of cathode tab.

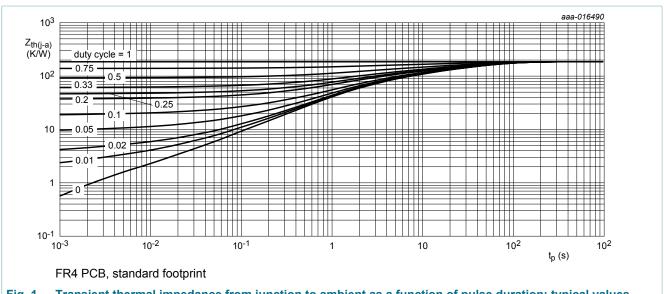


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

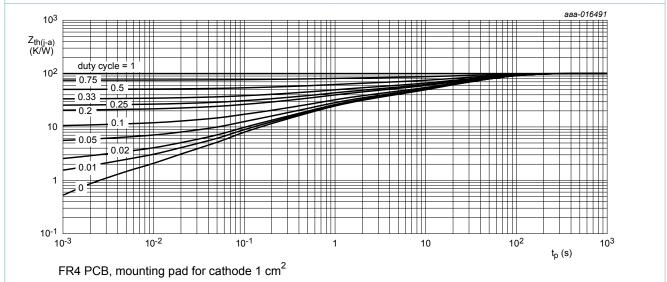
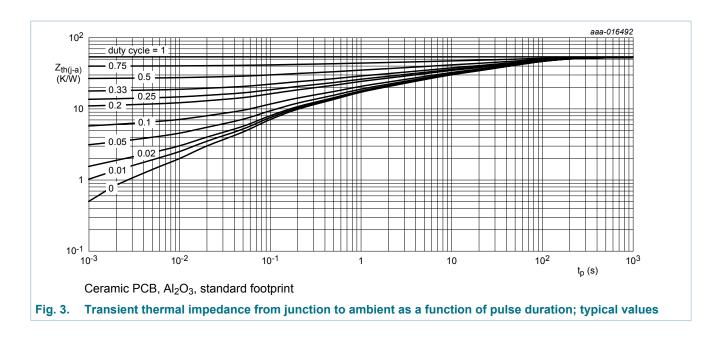


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

4 / 15



10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	I_R = 1 mA; t_p = 300 μs; δ = 0.02 ; T_j = 25 °C	100	-	-	V
V _F	forward voltage	$I_F = 0.1 \text{ A}; t_p \le 300 \mu\text{s}; \delta \le 0.02 ;$ $T_j = 25 ^{\circ}\text{C}$	-	470	520	mV
		$I_F = 0.5 \text{ A}; t_p \le 300 \mu\text{s}; \delta \le 0.02 ;$ $T_j = 25 ^{\circ}\text{C}$	-	580	630	mV
		$I_F = 0.7 \text{ A}; t_p \le 300 \mu\text{s}; \delta \le 0.02 ;$ $T_j = 25 ^{\circ}\text{C}$	-	610	670	mV
		I_F = 1 A; t_p ≤ 300 μs; δ ≤ 0.02 ; T_j = 25 °C	-	650	710	mV
		$I_F = 1.6 \text{ A}; t_p \le 300 \mu\text{s}; \delta \le 0.02 ;$ $T_j = 25 ^{\circ}\text{C}$	-	690	750	mV
		$I_F = 2 \text{ A}; t_p \le 300 \mu\text{s}; \delta \le 0.02 ;$ $T_j = 25 ^{\circ}\text{C}$	-	710	770	mV
		I_F = 2 A; t_p ≤ 300 μs; δ ≤ 0.02 ; T_j = 125 °C	-	575	650	mV
I _R r	reverse current	$V_R = 10 \text{ V}; t_p \le 300 \mu\text{s}; \delta \le 0.02 ;$ $T_j = 25 ^{\circ}\text{C}$	-	10	-	nA
		$V_R = 60 \text{ V}; t_p \le 300 \mu\text{s}; \delta \le 0.02 ;$ $T_j = 25 ^{\circ}\text{C}$	-	25	-	nA
		$V_R = 100 \text{ V}; t_p \le 300 \mu\text{s}; \delta \le 0.02 ;$ $T_j = 25 ^{\circ}\text{C}$	-	70	300	nA
		$V_R = 100 \text{ V}; t_p \le 300 \mu\text{s}; \delta \le 0.02 ;$ $T_j = 125 ^{\circ}\text{C}$	-	120	1000	μA
C_d	diode capacitance	V _R = 1 V; f = 1 MHz; T _j = 25 °C	-	135	-	pF
		V _R = 4 V; f = 1 MHz; T _j = 25 °C	-	80	-	pF
		V _R = 10 V; f = 1 MHz; T _j = 25 °C	-	50	-	pF
rr	reverse recovery time	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 ^{\circ}\text{C}$	-	5	-	ns
V_{FRM}	peak forward recovery voltage	$I_F = 0.5 \text{ A}; dI_F/dt = 20 \text{ A/}\mu\text{s}; T_j = 25 ^{\circ}\text{C}$	-	610	-	mV

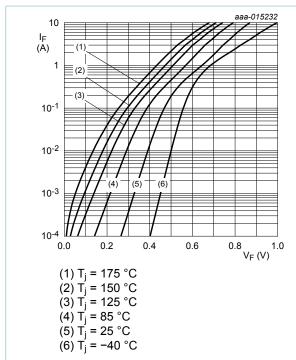


Fig. 4. Forward current as a function of forward voltage; typical values

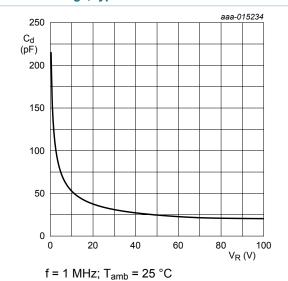


Fig. 6. Diode capacitance as a function of reverse voltage; typical values

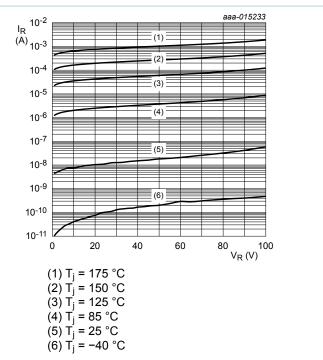


Fig. 5. Reverse current as a function of reverse voltage; typical values

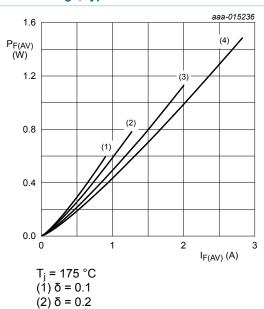
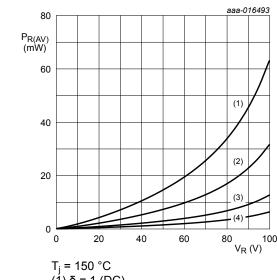


Fig. 7. Average forward power dissipation as a function of average forward current; typical values

(3) $\delta = 0.5$ (4) $\delta = 1$



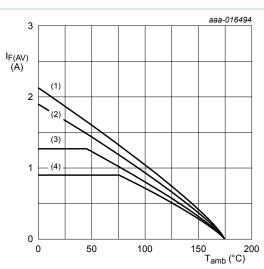
 $(1) \delta = 1 (DC)$

(2) δ = 0.5; f = 20 kHz

(3) δ = 0.2; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Average reverse power dissipation as a Fig. 8. function of reverse voltage; typical values



FR4 PCB, standard footprint

 $T_i = 175 \,{}^{\circ}\text{C}$

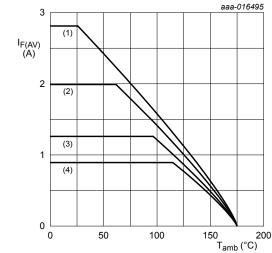
 $(1) \delta = 1; DC$

(2) $\delta = 0.5$; f = 20 kHz

(3) $\delta = 0.2$; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Average forward current as a function of Fig. 9. ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm²

 $T_i = 175 \,{}^{\circ}\text{C}$

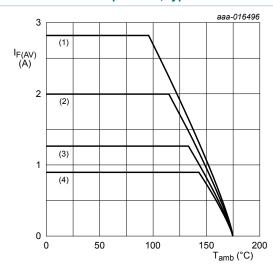
 $(1) \delta = 1; DC$

(2) δ = 0.5; f = 20 kHz

(3) δ = 0.2; f = 20 kHz

(4) $\delta = 0.1$; f = 20 kHz

Fig. 10. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al₂O₃, standard footprint

 $T_i = 175 \,{}^{\circ}\text{C}$

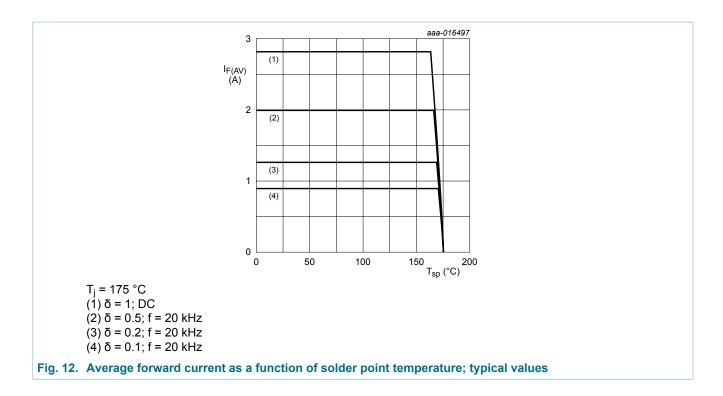
 $(1) \delta = 1; DC$

(2) δ = 0.5; f = 20 kHz

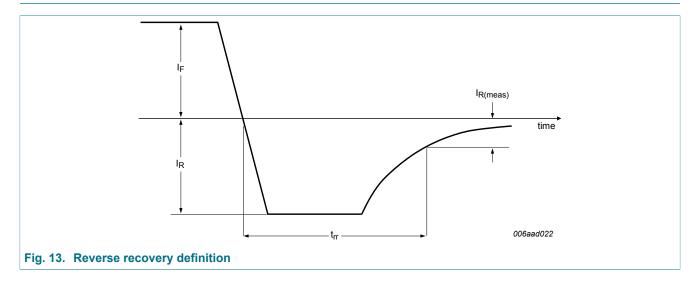
(3) $\delta = 0.2$; f = 20 kHz

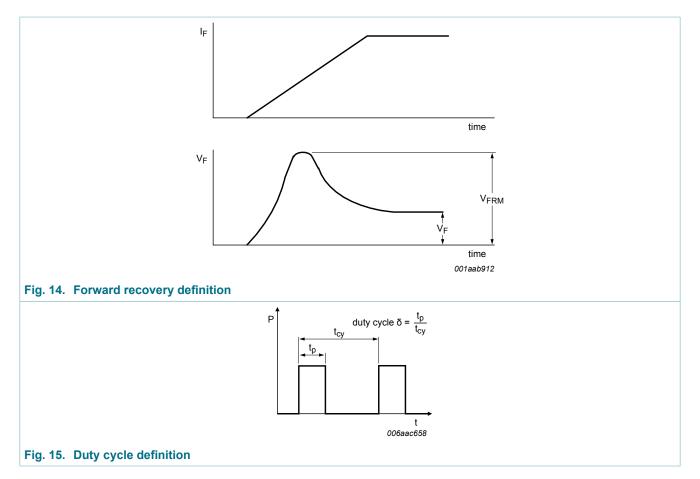
(4) $\delta = 0.1$; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



11. Test information



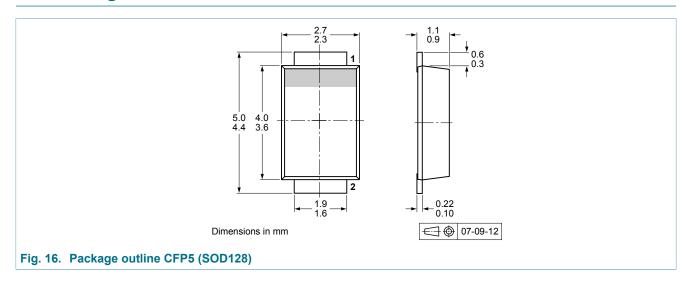


The current ratings for the typical waveforms are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

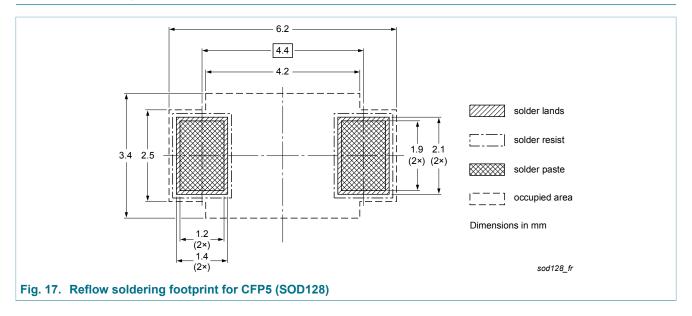
Quality information

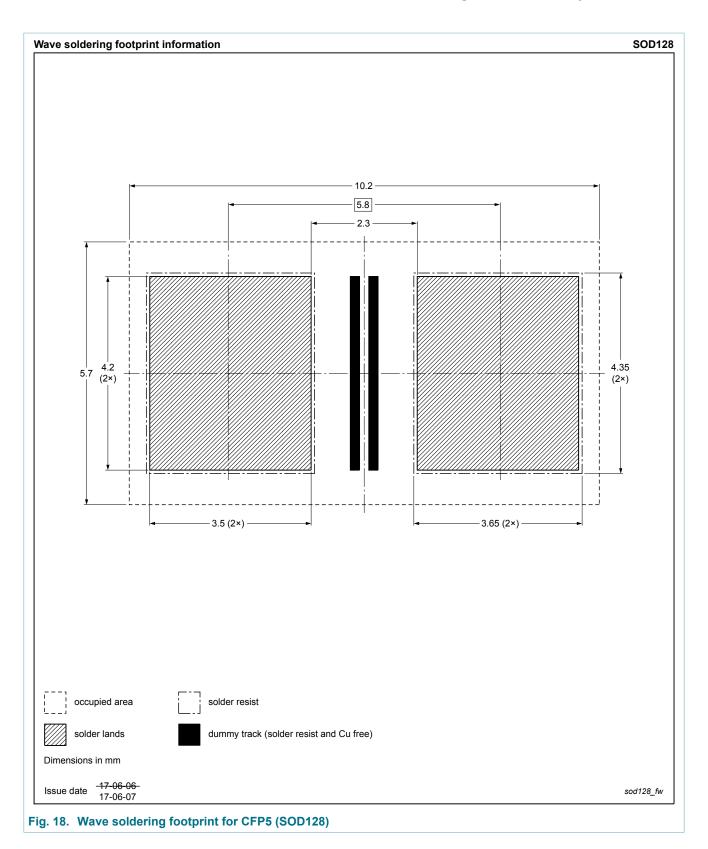
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline



13. Soldering





14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes				
PMEG10020AELP v.2	20171129	Product data sheet	-	PMEG10020AELP v.1				
Modifications:		 Features and benefits: Capable for reflow and wave soldering added Soldering: Wave soldering footprint added 						
PMEG10020AELP v.1	20150507	Product data sheet	-	-				

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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PMEG10020AELP

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16. Contents

1.	General description	1
2.	Features and benefits	1
3.	Applications	1
4.	Quick reference data	1
5.	Pinning information	2
6.	Ordering information	2
7.	Marking	2
8.	Limiting values	3
9.	Thermal characteristics	3
10.	Characteristics	€
11.	Test information	9
12.	Package outline	. 11
13.	Soldering	. 11
14.	Revision history	13
15.	Legal information	. 14

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